



### 4-Bit I2C-Bus and SMBus Low Power I/O Port

#### **Features**

- → Operation Power Supply Voltage from 2.3V to 5.5V
- → 4-bit I<sup>2</sup>C-Bus GPIO with 5V Tolerant I/Os
- → Polarity Inversion Register
- → Low Current Consumption
- → 0Hz to 1MHz Clock Frequency
- → Noise Filter on SCL/SDA Inputs
- → Power-on Reset
- → Four I/O pins Default to Four Inputs with 100kΩ Pullup Resistor
- → ESD Protection (4KV HBM and 1KV CDM)
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → Offered in Three Different Packages:
  - SOIC-8(W)
  - MSOP-8(U)
  - UDFN-8(ZW)

**Pin Configuration** 

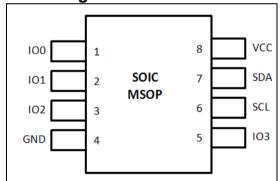


Figure 1: SOIC-8 & MSOP-8

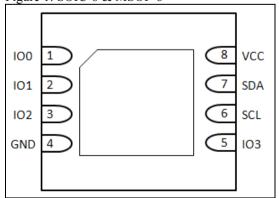


Figure 2: UDFN 2x3-8

## **Description**

The PI4IOE5V9536 provides 4 bits of general purpose parallel input/output (GPIO) expansion for I<sup>2</sup>C-bus/ SMBus applications. It includes features like higher driving capability, 5V tolerance, lower power supply, individual I/O configuration, and smaller packaging. It provides a simple solution when an additional I/O is required for ACPI power switches, sensors, push buttons, LEDs, fans, etc.

The PI4IOE5V9536 consists of 4-bit registers to configure the I/Os as either inputs or outputs and 4-bit polarity registers to change the polarity of the input-port register data The data for each input or output is kept in the corresponding input-port or output-port register. All registers can be read by the system master.

# **Pin Description**

\* I = Input; O = Output; P = Power; G = Ground

Pin	Name	Type	Description
1	IO0	I/O	Input/Output 0
2	IO1	I/O	Input/Output 1
3	IO2	I/O	Input/Output 2
4	GND	G	Supply Ground
5	IO3	I/O	Input/Output 3
6	SCL	I	Serial Clock Line
7	SDA	I/O	Serial Data Line
8	VCC	P	Power Supply

#### Notes:

<sup>1.</sup> No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>







# **Maximum Ratings**

Power Supply	0.5V to +6.0V
Voltage on an I/O pin	GND-0.5V to +6.0V
Input Current	±20mA
Output Current on I/O pin	±50mA
Supply Current	85mA
Ground Supply Current	100mA
Total Power Dissipation	200mW
Operation Temperature	40°C ~85°C
Storage Temperature	65°C ~150°C
Maximum Junction Temperature ,T j(max)	125°C

#### Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### **Static Characteristics**

VCC = 2.3V to 5.5V; GND = 0V; Tamb= -40°C to +85°C; unless otherwise specified.

Table 2: Static Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Power Sup	ply					
VCC	Supply Voltage	_	2.3	_	5.5	V
T	Supply Current	Operating mode; VCC = 5.5V; no load; fSCL = 1MHz,	_	100	150	μΑ
$I_{CC}$	Supply Current	Operating mode; VCC = 2.3V; no load; fSCL = 1MHz	_	20	40	μΑ
T	Standles Comment	Standby mode; VCC = 5.5V; no load; VI = GND; fSCL = 0 kHz; I/O = inputs	_	225	350	μΑ
$I_{stb}$	Standby Current	Standby mode; VCC = 5.5V; no load; VI = VCC; fSCL = 0 kHz; I/O = inputs	_	0.25	1	μΑ
$V_{POR}$	Power-on Reset Voltage <sup>[1]</sup>	_	_	1.16	1.41	V
Input SCL,	Input/Output SDA					
$V_{IL}$	Low-Level Input Voltage	_	-0.5		+0.3VCC	V
$V_{\mathrm{IH}}$	High-Level Input Voltage	_	0.7VCC	_	5.5	V
$I_{OL}$	Low-Level Output Current	$V_{OL}=0.4V$	3	6	_	mA
$I_{\rm L}$	Leakage Current	$V_I = VCC = GND$	-1		1	μΑ
$C_{i}$	Input Capacitance	$V_I = GND$	_	6	10	pF





Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I/Os		1	1		l	
$V_{\mathrm{IL}}$	Low-Level Input Voltage	_	-0.5	_	+0.81	V
$V_{\mathrm{IH}}$	High-Level Input Voltage	_	+1.8	_	5.5	V
		$VCC = 2.3V; V_{OL} = 0.5V^{[2]}$	8	10	_	mA
		$VCC = 2.3V; V_{OL} = 0.7V^{[2]}$	10	13	_	mA
T	Lave Lavel Outrot Comment	$VCC = 3.0V; V_{OL} = 0.5V^{[2]}$	8	14	_	mA
$1_{ m OL}$	I <sub>OL</sub> Low-Level Output Current	$VCC = 3.0V; V_{OL} = 0.7V^{[2]}$	10	19	_	mA
		$VCC = 4.5V; V_{OL} = 0.5V^{[2]}$	8	17	_	mA
		$VCC = 4.5V; V_{OL} = 0.7V^{[2]}$	10	24	_	mA
		$I_{OH} = -8 \text{mA}; VCC = 2.3 V^{[3]}$	1.8	_	_	V
		$I_{OH} = -10 \text{mA}; VCC = 2.3 V^{[3]}$	1.7	_	_	V
<b>3</b> 7	High Land Output Walters	$I_{OH} = -8 \text{mA}; VCC = 3.0 V^{[3]}$	2.6	_	_	V
$V_{\mathrm{OH}}$	High-Level Output Voltage	$I_{OH} = -10 \text{mA}; VCC = 3.0 V^{[3]}$	2.5	_	_	V
		$I_{OH} = -8 \text{mA}; VCC = 4.75 V^{[3]}$	4.1	_	_	V
		$I_{OH} = -10 \text{mA}; VCC = 4.75 V^{[3]}$	4.0	_	_	V
$I_{LIH}$	High-Level Input Leakage Current	$VCC = 3.6V; V_I = VCC$		_	1	μΑ
$I_{LIL}$	Low-Level Input Leakage Current	$VCC = 5.5V$ ; $V_I = GND$	_	_	-100	μΑ
Ci	Input Capacitance	_		3.7	10	pF
C <sub>o</sub>	Output Capacitance	_	_	3.7	10	pF

Notes:
1. VCC must be lowered to 0.2V for at least 5µs in order to reset part.
2. Each I/O must be externally limited to a maximum of 25mA, and the device must be limited to a maximum current of 100mA

<sup>3.</sup> The total current sourced by all I/Os must be limited to 85mA.







# **Dynamic Characteristics**

Table 3: Dynamic Characteristics

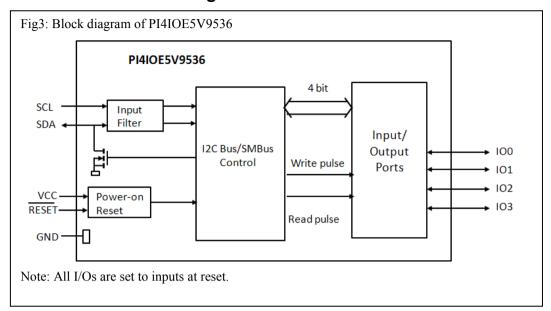
Symbol	Parameter	Test	Stand Mode			Mode <sup>2</sup> C	Fast Mode Plus I <sup>2</sup> C		Unit
Symbol	i ai ainetei	Conditions	Min	Max	Min	Max	Min	Max	Oiii
$f_{SCL}$	SCL Clock Frequency	_	0	100	0	400	0	1000	kHz
$t_{ m BUF}$	Bus Free Time Between a STOP and START Condition	_	4.7	_	1.3	_	0.5	_	μs
$t_{\rm HD;STA}$	Hold Time (Repeated) START Condition	_	4.0	_	0.6		0.26		μs
$t_{\mathrm{SU;STA}}$	Setup Time for a Repeated START Condition	_	4.7	_	0.6		0.26		μs
$t_{\mathrm{SU;STO}}$	Setup Time for STOP Condition	_	4.0		0.6		0.26		μs
$t_{VD;ACK}^{}^{}[1]$	Data Valid Acknowledge Time	_		3.45		0.9	_	0.45	μs
$t_{\text{HD;DAT}}^{[2]}$	Data Hold Time	_	0	_	0	_	0	_	ns
$t_{VD;DAT} \\$	Data Valid Time	_	_	3.45	_	0.9	_	0.45	μs
t <sub>SU;DAT</sub>	Data Setup Time	_	250	_	100	_	50	_	ns
$t_{ m LOW}$	LOW Period of the SCL Clock	_	4.7	_	1.3	_	0.5	_	μs
$t_{ m HIGH}$	HIGH Period of the SCL Clock	_	4.0	_	0.6		0.26	_	μs
$t_{\mathrm{f}}$	Fall Time of both SDA and SCL Signals	_	_	300	_	300	_	120	ns
$t_{\rm r}$	Rise Time of both SDA and SCL Signals	_	_	1000	_	300	_	120	ns
$t_{SP}$	Pulse Width of Spikes that must be Suppressed by the Input Filter	_	_	50	_	50	_	50	ns
Port Timi	ng								
$t_{v(Q)}$	Data-Output Valid Time <sup>[3]</sup>	_	_	200	_	200	_	200	ns
$t_{su(D)}$	Data-Input Set-Up Time	_	100		100		100	_	ns
$T_{h\left(D\right)}$	Data-Input Hold Time	_	1	_	1	_	1		μs

<sup>1.</sup>  $t_{\text{VD;ACK}}$  = time for acknowledgement signal from SCL LOW to SDA (out) LOW.

<sup>2.</sup>  $t_{VD;DAT}$  = minimum time for SDA data out to be valid following SCL LOW. 3.  $t_{v(Q)}$ measured from 0.7VCC on SCL to 50% I/O output.



# PI4IOE5V9536 Block Diagram



# **Details Description**

# a. Device Address

Table 4: Device Address

	b7(MSB)	b6	b5	b4	b3	b2	b1	b0
Address Byte	1	0	0	0	0	0	1	R/W

Note: Read "1", Write "0"

# b. Registers

### i. Command Byte

The command byte is the first byte to follow the address byte during a write transmission. It is used as a pointer to determine which of the following registers will be written or read.

Table 5: Command Byte

Command	Register
0	Input Port Register
1	Output Port Register
2	Polarity Inversion Register
3	Configuration Register





## ii. Register 0: Input Port Registers

This register is a read-only port. It reflects the incoming logic levels of the pins, regardless of whether the pin is defined as an input or an output by Register 2. Writes to this register have no effect.

The default value 'X' is determined by the externally applied logic level.

Table 6: Input Port 0 Register

Bit	7	6	5	4	3	2	1	0
Symbol	I7	I6	I5	I4	I3	I2	I1	10
Default	1	1	1	1	X	X	X	X

### iii. Register 1:Output Port Register

This register is an output-only port. It reflects the outgoing logic levels of the pins defined as outputs by Registers 3. Bit values in this register have no effect on pins defined as inputs. In turn, reads from this register reflect the value that is in the flip-flop controlling the output selection, not the actual pin value.

Table 8: Output Port 0 Register

Bit	7	6	5	4	3	2	1	0
Symbol	О7	O6	O5	O4	О3	O2	O1	О0
Default	1	1	1	1	1	1	1	1

#### iv. Register 2: Polarity Inversion Register

This register allows the user to invert the polarity of the input port register data. If a bit in this register is set (written with '1'), the input port data polarity is inverted. If a bit in this register is cleared (written with a '0'), the input port data polarity is retained.

Table 10: Polarity Inversion Port 0 Register

Bit	7	6	5	4	3	2	1	0
Symbol	N7	N6	N5	N4	N3	N2	N1	N0
Default	0	0	0	0	0	0	0	0

#### v. Register 3: Configuration Registers

This register configures the directions of the I/O pins. If a bit in this register is set (written with '1'), the corresponding port pin is enabled as an input with a high-impedance output driver. If a bit in this register is cleared (written with '0'), the corresponding port pin is enabled as an output. At reset, the I/Os are configured as inputs with a weak pullup to VCC.

Table 12: Configuration Port 0 Register

Bit	7	6	5	4	3	2	1	0
Symbol	C7	C6	C5	C4	C3	C2	C1	C0
Default	1	1	1	1	1	1	1	1





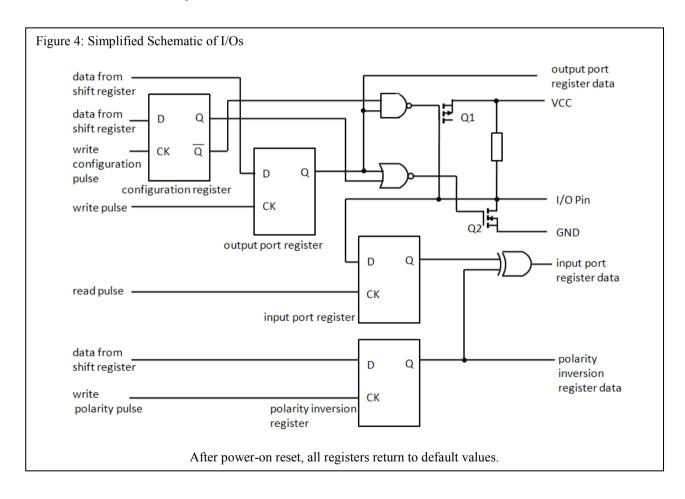
#### c. Power-on Reset

When power is applied to VCC, an internal power-on reset holds the PI4IOE5V9536 in a reset condition until VCC reaches  $V_{POR}$ . At that point, the reset condition is released, and the PI4IOE5V9536 registers and SMBus state machine initialize to their default states. Thereafter, VCC must be lowered below 0.2 V to reset the device. For a power reset cycle, VCC must be lowered below 0.2 V and then restored to the operating voltage.

### d. I/O Port

When an I/O is configured as an input, FETs Q1 and Q2 are off, creating a high-impedance input. The input voltage may be raised above VCC to a maximum of 5.5 V.

If the I/O is configured as an output, then either Q1 or Q2 is on, depending on the state of the output port register. Care must be exercised if an external voltage is applied to an I/O configured as an output because of the low-impedance path that exists between the pin and either VCC or GND.

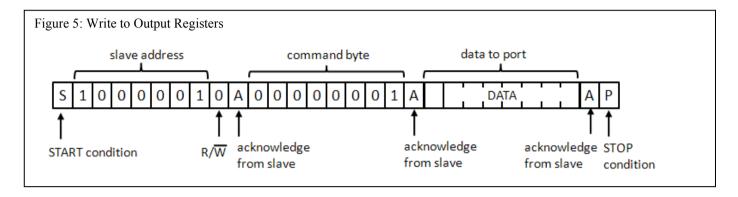


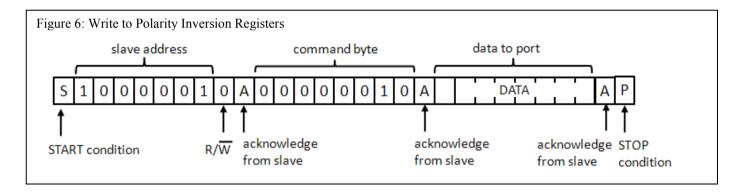


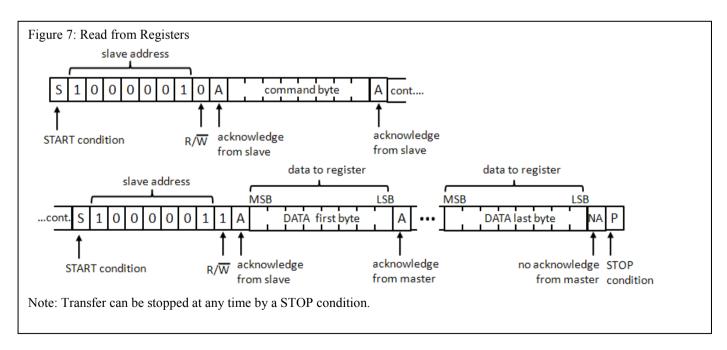


#### e. Bus Transaction

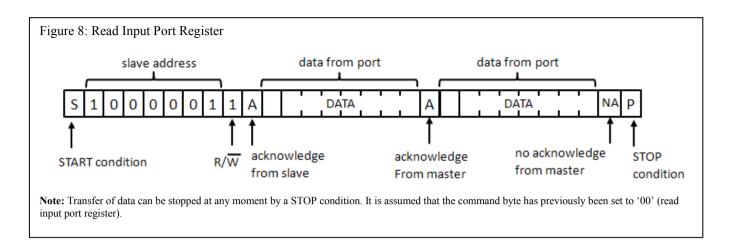
Data is transmitted to the PI4IOE5V9536 using the write mode as shown in Figure 5. Data is read from the PI4IOE5V9536 using the read mode as shown in Figure 7. These devices do not implement an auto-increment function, so once a command byte is sent, the register that was addressed continues to be accessed by reads until a new command byte is sent.



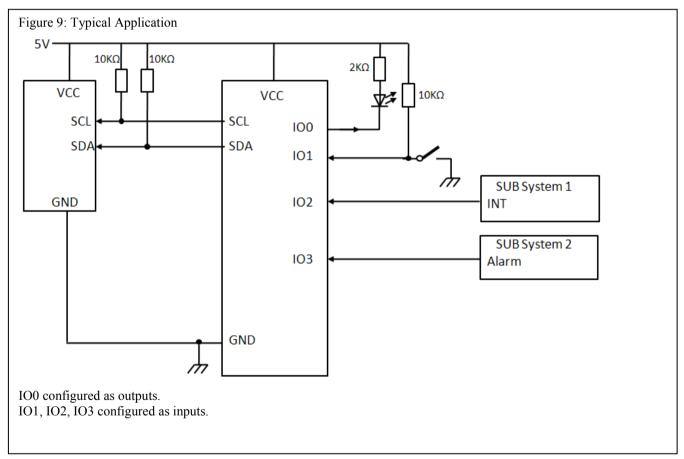








# **Application Design-in Information**







# **Part Marking**

U Package

IOE5V9 536UE ABKG

AB: Date Code (Year & Workweek)

K: Assembly Site Code G: Wafer Fab Site Code

Bar above "G" means Cu wire

W Package and ZW Package

Top mark not available at this time. To obtain advanced information regarding the top mark, contact your local sales representative.

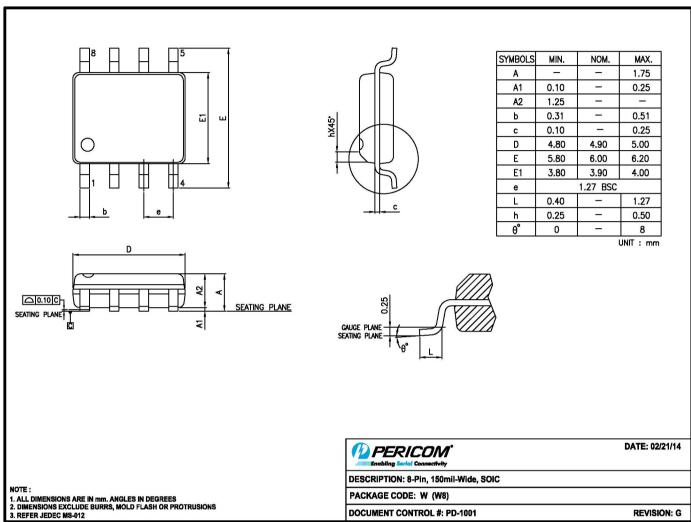






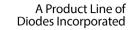
# **Packaging Mechanical**

SOIC-8 (W)



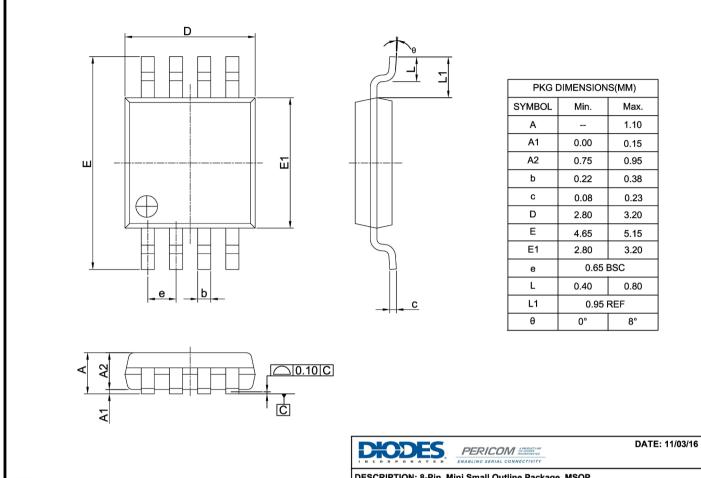
15-0103







# MSOP-8 (U)



1. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES IN DEGREES.

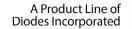
2. REFER JEDEC MO-187F/AA
3. PACKAGE OUTLINE DIMENSIONS DO NOT INCLUDE MOLD FLASH AND METAL BURR.

DESCRIPTION: 8-Pin, Mini Small Outline Package, MSOP

PACKAGE CODE: U (U8)

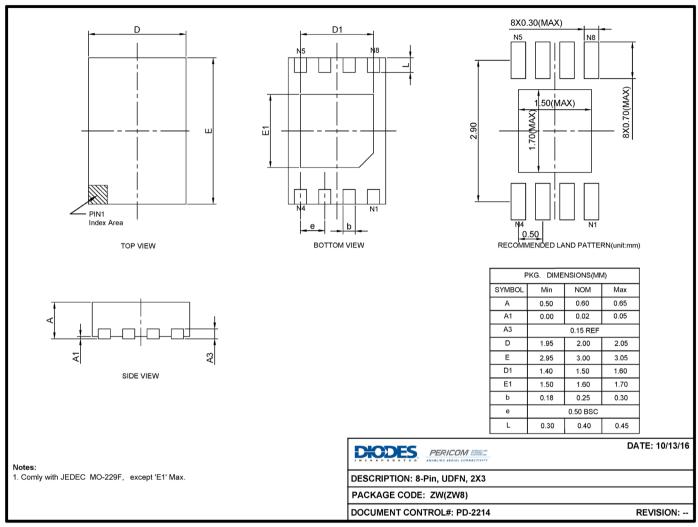
DOCUMENT CONTROL #: PD-1261 REVISION: G







### UDFN-8 (ZW)



16-0176

#### For latest package information:

 $See \ http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/.$ 

# **Ordering Information**

Part Number	Package Code	Package Description
PI4IOE5V9536WEX	W	8-Pin,150mil-Wide (SOIC)
PI4IOE5V9536UEX	U	8-Pin, Mini Small Outline Package (MSOP)
PI4IOE5V9536ZWEX	ZW	8-Pin, 2x3 (UDFN)

### Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant.
- 2. See http://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Thermal characteristics can be found on the company web site at www.diodes.com/design/support/packaging/
- E = Pb-free and Green
- $_{5}$  X suffix = Tape/Reel





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PCA9555PW.112 MIC74YQS ADP5585ACBZ-00-R7 ADP5585ACBZ-04-R7 EM4095HMSO16A HTRC11001T/02EE ADP5587ACPZ-1-R7 ADP5587ACPZ-R7 ADP5585ACPZ-01-R7 ADP5586ACBZ-00-R7 PCF8574P XD8574AP XD8574P XD8255-2 XD82C55-5
XD71055 EM4095HMSO16B ECE1088-DZK KTS1620EWA-TR MAX7311AWG+ MCP25025-ISL MCP25020-I/SL
PI4IOE5V9555ZDEX MAX7300ATL+ MCP23008-E/SS MCP23009-E/SS MAX7325ATG+T MCP23016-I/SO MCP23S17-E/SO MAX7300AAI+ MAX7312AUG+ MAX7315AEE+ MAX7317AEE+ MAX7321AEE+ MCP25020-I/P